## TSCDT16065G1 Taiwan Semiconductor

# 16A, 650V SiC Merged PIN Schottky Diode

### FEATURES

- Max junction temperature 175°C
- MPS structure for high ruggedness to forward current surge events
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V<sub>F</sub>
- RoHS compliant
- Halogen-free

### APPLICATIONS

- General purpose
- Switch mode power supplies
- Power factor correction

## **MECHANICAL DATA**

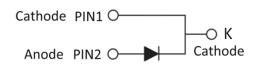
- Case: TO-220AC-2L
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Polarity: As circuit diagram
- Weight: 2.03g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
lf	16	А		
V <sub>RRM</sub>	650	V		
I <sub>FSM</sub>	100	А		
T <sub>J MAX</sub>	175	°C		
Package	TO-220AC-2L			
Configuration	Single die			









ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	VALUE	UNIT	
Repetitive peak reverse voltage		Vrrm	650	V	
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	455	V	
Continuous Rectified Forward Current @ TJ = 149°C		lF	16	А	
Surge peak forward current 10ms single half sine-wave superimposed on rated load	$T_C = 25^{\circ}C$		100	А	
	Tc = 125°C	IFSM	80	А	
Junction temperature		TJ	-55 to +175	°C	
Storage temperature		T <sub>STG</sub>	-55 to +175	°C	





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	MAX	UNIT
Junction-to-case thermal resistance	R <sub>ejc</sub>	0.98	1.18	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 8A, T_J = 25^{\circ}C$	VF	1.16	-	V
	I <sub>F</sub> = 16A, T <sub>J</sub> = 25°C		1.38	1.45	V
	$I_F = 8A, T_J = 150^{\circ}C$		1.21	-	V
	$I_F = 16A, T_J = 150^{\circ}C$		1.60	-	V
	I⊧ = 8A, T」 = 175°C		1.23	-	V
	I⊧ = 16A, TJ = 175°C		1.68	1.85	V
Reverse current @ rated $V_{R}^{(2)}$	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	20	μA
	T <sub>J</sub> = 175°C		-	200	μA
Junction capacitance	$f = 1MHz, V_R = 1V$	CJ	638	-	pF
	$f = 1MHz, V_R = 200V$		100	-	pF
	$f = 1MHz, V_R = 400V$		70	-	pF
Capacitive Charge	V <sub>R</sub> = 400V	Qc	49	-	nC

#### Notes:

1. Pulse test with PW = 0.3ms

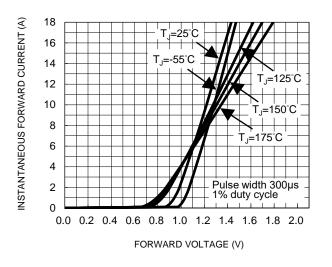
2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSCDT16065G1	TO-220AC-2L	50 / Tube		



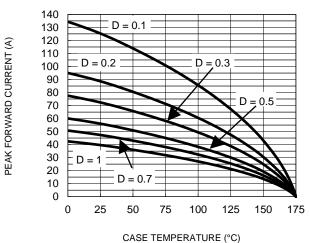
## **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

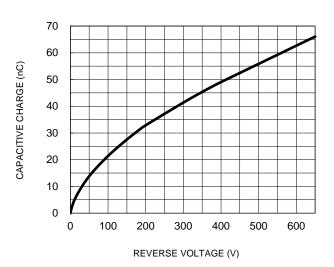


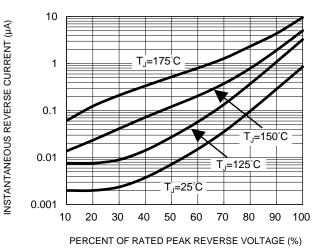
**Fig.1 Typical Forward Characteristics** 

#### Fig.3 Peak forward current versus case temperature



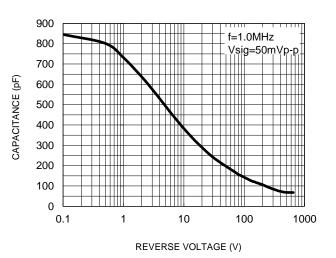




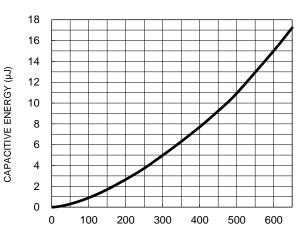


#### Fig.2 Typical Reverse Characteristics

Fig.4 Typical Junction Capacitance



#### FIG.6 Typical Capacitance Stored Energy



REVERSE VOLTAGE (V)



## **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

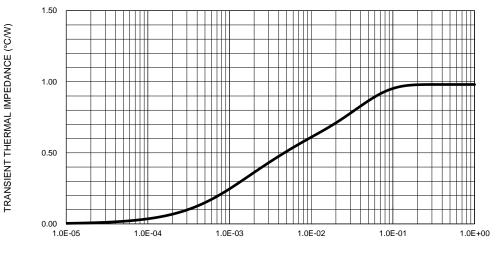


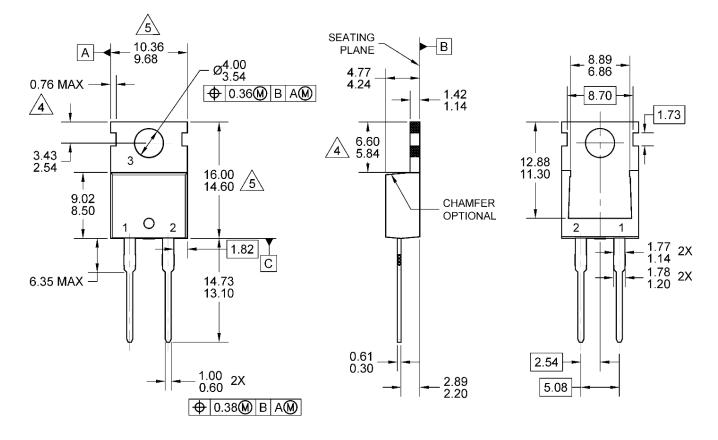
Fig.7 Typical Transient Thermal Characteristics

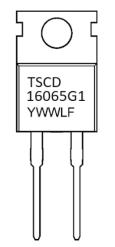
PULSE DURATION (s)



## PACKAGE OUTLINE DIMENSIONS







MARKING DIAGRAM

- Y = YEAR CODE
- WWW = WEEK CODE (01~52)
- L = LOT CODE (1~9, A~Z)
- F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-220, VARIATION AC, ISSUE K.
- 4 THE DEFINED ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. SLOT AND NOTCH MAY APPEAR IN THIS ZONE.
- 5 THIS DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- 6. DWG NO REF: HQ2SD07-TO220ACSiC-119 REV A.



# TSCDT16065G1

Taiwan Semiconductor

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